

DECLARATION AND POWER OF ATTORNEY

As a below inventor, I hereby declare that:

My residence, mailing address and citizenship are as stated below next to my name.

I believe I am an original, first and SOLE inventor of the subject matter which is claimed and for which a patent is sought by patent application filed on the invention entitled:

BRUSHLESS RESOLVER AND ITS CONSTRUCTING METHOD

said patent application having been assigned **international application no. PCT/JP2003/013541** having an **international filing date of 23 October 2003**.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or (f), or 365(b) of any foreign application(s) for patent or inventor's certificate(s), or 365(a) of any PCT international application which designated at least one country other than the United States of America, listed below and have also identified below, by checking the box, any foreign application(s) for patent or inventor's certificate(s), or any PCT international application having a filing date before that of the application on which priority is claimed:

Prior Foreign Application Number(s)	Country	Foreign Filing Date (MM/DD/YYYY)	Priority Claimed?	Certified Copy Attached?

I hereby claim the benefit under 35 U.S.C. 119(e) of United States provisional application(s) listed below.

Application Number(s)	Day/Month/Year Filed	Additional Provisional Application Numbers Listed on Supplemental Priority Data Sheet Attached

I hereby claim the benefit under Title 35, United States, § 120 of any United States application(s) or any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information which is material to patentability as defined in Title 37, of Federal Regulations Code, § 1.56(a) which became available between the filing date of the prior application and the national or PCT international filing date of this application:

U.S. Parent Application or PCT Parent Number	Parent Filing Date Day/Month/Year Filed	Parent Patent Number (if applicable)

POWER OF ATTORNEY: As a named inventor, I hereby appoint the Attorneys associated with Customer No. 027885, to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

DIRECT TELEPHONE CALLS TO:

Richard J. Minnich
Telephone: 216-861-5582
Facsimile: 216-241-1666
Email: rminnich@faysharpe.com

DIRECT ALL CORRESPONDENCE TO:

Richard J. Minnich
Fay, Sharpe, Fagan, Minnich & McKee, LLP
1100 Superior Avenue, 7th Floor
Cleveland, OH 44114-2579

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Name of Sole Inventor:

Satoshi Kimura

Inventor's Signature:

Satoshi Kimura

Date:

May 8, 2006

Residence:

c/o Hachinohe-plant

Tamagawa Seiki Co., Ltd.

1-3-47, Kita-inter-kougyou-danchi

Hachinohe-shi Aomori 039-2245 Japan

Country of Citizenship:

Japan

Mailing Address:

c/o Hachinohe-plant

Tamagawa Seiki Co., Ltd.

1-3-47, Kita-inter-kougyou-danchi

Hachinohe-shi Aomori 039-2245 Japan